

## Features

- 0402 and 0603 package options
- Rated for IEC 61000-4-2, level 4
- Withstands multiple ESD strikes
- Low capacitance and leakage currents for invisible load protection
- Tape and reel packaging

## ChipGuard® MLD Series Varistor ESD Clamp Protectors

### Description

The Chip Guard® CG0402MLD and CG0603MLD Series have been specifically designed to protect sensitive electronic components from electrostatic discharge damage. The MLD family has been designed to protect equipment to IEC61000-4-2, level 4 ESD specifications targeted for high speed data applications. The Chip Guard® MLD Series has been manufactured to provide very low capacitance with excellent clamp qualities, making the family almost transparent under normal working conditions.

### Electrical Characteristics @ 25 °C (unless otherwise noted)

Model	Continuous Operating Voltage	Breakdown Voltage	Clamping Voltage	Off-state Current	Capacitance
	V <sub>DC</sub> (V)	V <sub>B</sub> @ 1 mA (V)	V <sub>C</sub> @ 1 A 8/20 μs (V)	I <sub>L</sub> (μA)	C <sub>OFF</sub> (pF)
	Max.	Typ.	Max.	Max.	Max.
CG0402MLD-12G	12	50	140	1	5
CG0603MLD-12E	12	50	140	1	5

### Environmental Characteristics

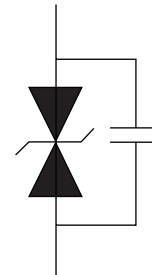
Operating Temperature ..... -30 °C to +85 °C  
 Storage Temperature..... -30 °C to +85 °C  
 Standard..... IEC 61000-4-2 Level 4

These products are RoHS compliant. There is some lead contained within the glass of the ceramic. This is acceptable under exemption no. 5 of the RoHS directive (DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment).

### ESD Withstand Ratings

Parameter	Peak Voltage	Repetitions (Min.)
ESD Voltage Capability, Contact Discharge	8 kV	100 at 8 kV
ESD Voltage Capability, Air Discharge	15 kV	100 at 15 kV
Standard	IEC61000-4-2 Level 4	

### Schematic



### How to Order

**CG 0n0n MLD - 12 x**

ChipGuard®  
 Product Designator \_\_\_\_\_

Package Option \_\_\_\_\_  
 0402 = 0402 Package  
 0603 = 0603 Package

Multilayer Series Designator \_\_\_\_\_

Operating Voltage \_\_\_\_\_  
 12 = 12 V

Tape & Reel Packaging \_\_\_\_\_  
 E = 4,000 pcs. per reel (CG0603MLD Series)  
 G = 10,000 pcs. per reel (CG0402MLD Series)

Ni barrier terminations are standard on all ChipGuard® part numbers.

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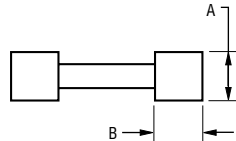
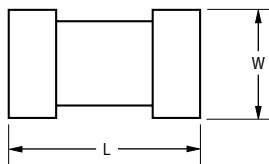
Europe: Tel: +41-41 768 5555 • Fax: +41-41 768 5510

The Americas: Tel: +1-951 781-5500 • Fax: +1-951 781-5700

[www.bourns.com](http://www.bourns.com)

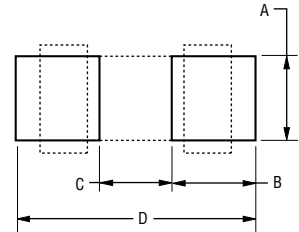
\*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011. Specifications are subject to change without notice. Customers should verify actual device performance in their specific applications.

## Product Dimensions



DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

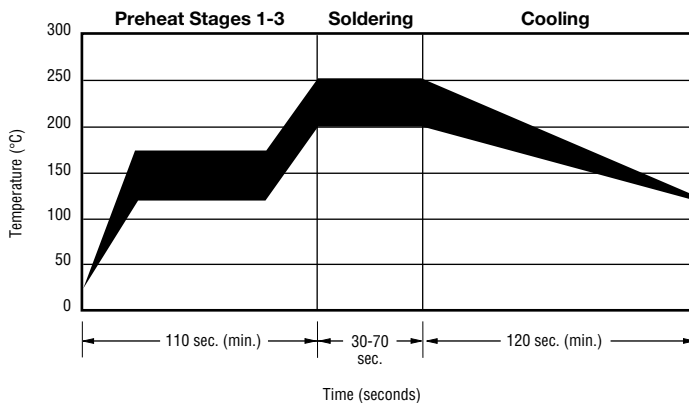
## Recommended Pad Layout



Dimension	CG0402MLD Series	CG0603MLD Series
L	$\frac{1.00 \pm 0.15}{(0.04 \pm 0.006)}$	$\frac{1.60 \pm 0.20}{(0.064 \pm 0.008)}$
W	$\frac{0.50 \pm 0.10}{(0.02 \pm 0.004)}$	$\frac{0.80 \pm 0.20}{(0.032 \pm 0.008)}$
A	$\frac{0.50 \pm 0.10}{(0.02 \pm 0.004)}$	$\frac{0.80 \pm 0.20}{(0.032 \pm 0.008)}$
B	$\frac{0.25 \pm 0.15}{(0.10 \pm 0.006)}$	$\frac{0.30 \pm 0.20}{(0.012 \pm 0.008)}$

Dim.	CG0402MLD Series	CG0603MLD Series
A	$\frac{0.51}{(0.020)}$	$\frac{0.76}{(0.030)}$
B	$\frac{0.61}{(0.024)}$	$\frac{1.02}{(0.040)}$
C	$\frac{0.51}{(0.020)}$	$\frac{0.50}{(0.020)}$
D	$\frac{1.70}{(0.067)}$	$\frac{2.54}{(0.100)}$

## Solder Reflow Recommendations



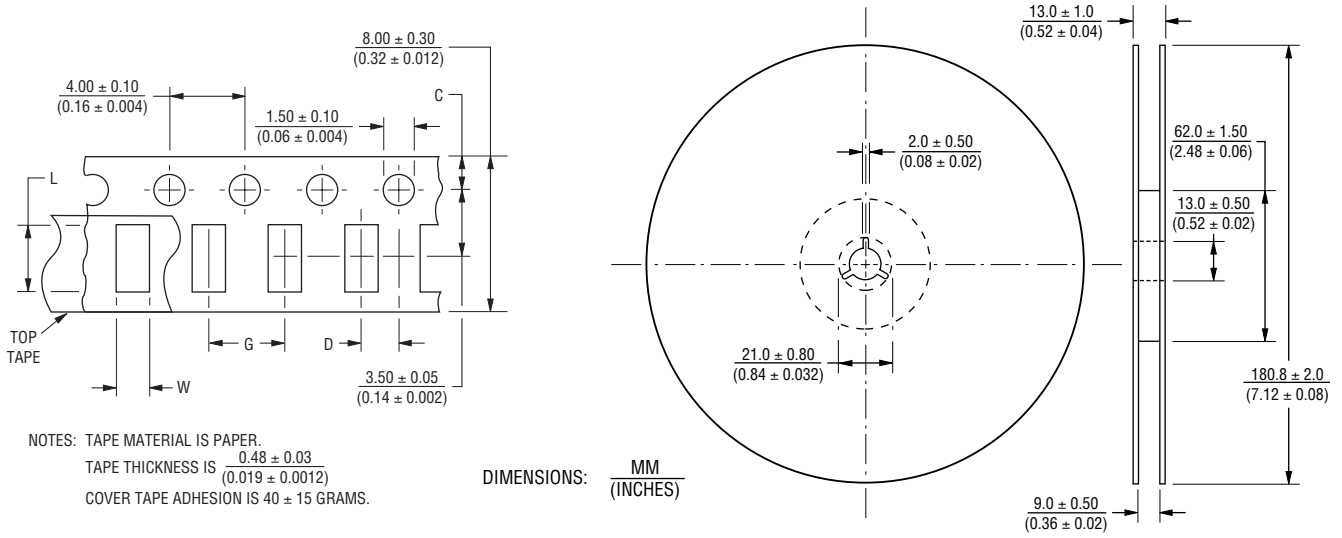
A	Stage 1 Preheat	Ambient to Preheating Temperature	30 s to 60 s
B	Stage 2 Preheat	140 °C to 160 °C	60 s to 120 s
C	Stage 3 Preheat	Preheat to 200 °C	20 s to 40 s
D	Main Heating	200 °C	60 s to 70 s
		210 °C	55 s to 65 s
		220 °C	50 s to 60 s
		230 °C	40 s to 50 s
		240 °C	30 s to 40 s
E	Cooling	200 °C to 100 °C	1 °C/s to 4 °C/s

- This product can be damaged by rapid heating, cooling or localized heating.
- Heat shocks should be avoided. Preheating and gradual cooling recommended.
- Excessive solder can damage the device. Print solder thickness of 150 to 200 um recommended.
- Solder gun tip temperature should be kept below 280 °C and should not touch the device directly. Contact should be less than 3 seconds. A solder gun under 30 watts is recommended.

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## Packaging Dimensions



Dimension	CG0402MLD Series	CG0603MLD Series
C	$\frac{1.75 \pm 0.05}{(0.04 \pm 0.002)}$	$\frac{1.75 \pm 0.10}{(0.04 \pm 0.004)}$
D	$\frac{2.00 \pm 0.02}{(0.08 \pm 0.0008)}$	$\frac{2.00 \pm 0.05}{(0.08 \pm 0.002)}$
L	$\frac{1.19 \pm 0.05}{(0.047 \pm 0.002)}$	$\frac{1.80 \pm 0.20}{(0.072 \pm 0.008)}$
W	$\frac{0.69 \pm 0.05}{(0.027 \pm 0.002)}$	$\frac{0.90 \pm 0.20}{(0.036 \pm 0.008)}$
G	$\frac{2.0 \pm 0.05}{(0.08 \pm 0.002)}$	$\frac{4.0 \pm 0.05}{(0.16 \pm 0.002)}$

REV. G 08/12

Specifications are subject to change without notice.  
Customers should verify actual device performance in their specific applications.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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